



SAMTM Data Sheet SAM-2900-9-10ps-x, λ = 2900 nm

Laser wavelength $\lambda = 2900 \text{ nm}$

High reflection band $\lambda = 2400 ... 3000 \text{ nm}$

Absorbance $A_0 = 9 \%$ Modulation depth $\Delta R = 4 \%$ Non-saturable loss $A_{ns} = 5 \%$

Saturation fluence $\Phi_{sat} = 150 \mu J/cm^2$

Relaxation time constant $\tau \sim 10 \text{ ps}$

Damage threshold $\Phi_{\text{sat}} = 2 \text{ mJ/cm}^2$

Chip area 4.0 mm x 4.0 mm; other dimensions on request

Chip thickness 620 µm

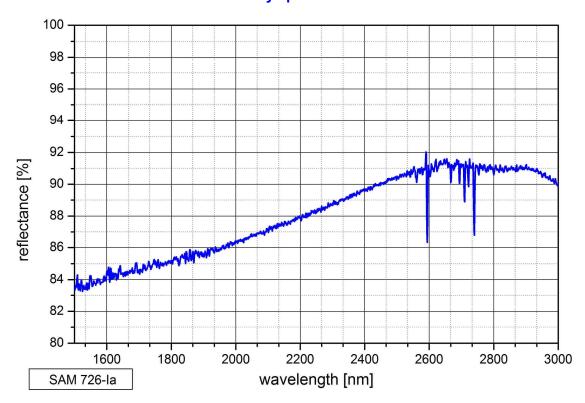
Reverse design the absorber layer is illuminated through the 620 µm thick GaAs wafer

Mounting option **x** denotes the type of mounting as follows:

x = 0 unmounted

x = 12.7 g glued on a copper heat sink with 12.7 mm diameter
x = 25.4 g glued on a copper heat sink with 25.4 mm diameter

Low intensity spectral reflectance





Reverse design of the SAM-2900-9-x-10ps

